

AUIRS2012S

Features

- High and low side gate driver
- Fully operational up to 200V
- Floating channel designed for bootstrap operation
- 2A source and sink currents
- Extended supply voltage range: 10V to 20V
- CMOS compatible inputs
- CMOS Schmitt-triggered inputs
- Outputs in phase with inputs
- Under Voltage Lock Out function
- Matched propagation delay times
- Automotive Qualified[†]
- Leadfree, RoHS compliant

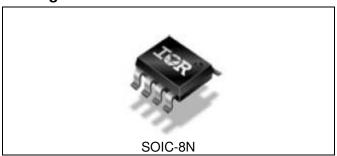
Typical Applications

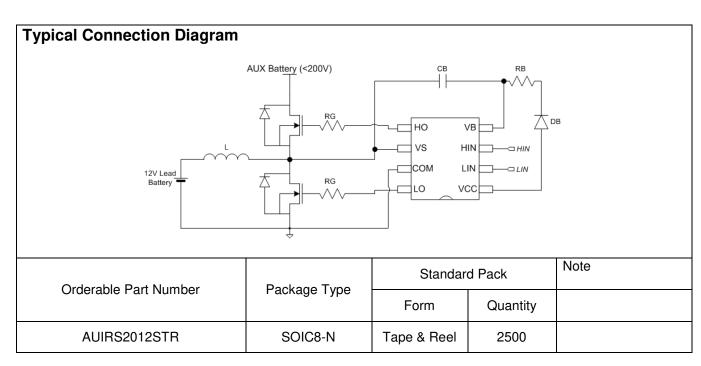
- Mid to low voltage DC-DC Converter for Micro and Mild Hybrid Vehicle
- Multiphase buck boost converters
- Direct Fuel Injection

Product Summary

Topology	High & Low Side Driver	
V _{S-MAX}	200V	
V _{OUT}	10V – 20V	
I ₀₊ & I ₀₋	2 A	
ton & toff	60ns (typ)	
Delay matching	20ns (max)	

Package







Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM lead. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

Symbol	Definition		Max.	Units	
V _{CC}	Fixed supply voltage	-0.3	20		
V_{LO}	Low Side output voltage	-0.3	VCC+0.3		
V_{IN}	Logic input voltage (HIN & LIN)	-0.3	5.0	V	
V_{B}	High side floating supply voltage -0.3 Vs+20		V		
Vs	High side floating offset voltage	VB-20	200		
V_{HO}	High Side floating output voltage	VS-0.3	VB+0.3		
dV _S /dt	Allowable offset transient	-	50	V/ns	
Rth_JA	Thermal resistance, junction to ambient	_	100	°C/W	
T_J	Junction temperature	_	150		
Ts	Storage temperature	-55	150	°C	
T _L	Lead temperature (soldering, 10 seconds)	_	300		

Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions. All voltage parameters are absolute voltage referenced to COM.

Symbol	Definition	Min.	Max.	Units
V _{cc}	Fixed supply voltage	10	20	
V_{LO}	Low Side output voltage	0	V _{CC}	
V_{IN}	Logic input voltage (HIN & LIN)		5.0	V
V_{B}	High side floating supply voltage	VS+10	VS+20	V
V_S	High side floating offset voltage	Note 1	200	
V_{HO}	High Side floating output voltage	VS	VB	
Fsw	Switching frequency**		400	kHz
Rin	Input resistance*		5k	Ω
T _A	Ambient Temperature	-40	125	°C

Note 1: Logic operational for VS of -5V to 200V. Logic state held of -5V to -VBS.

^{*} input resistance value to be calculated based on the desired rise time and switching frequency.

^{**} thermal balance to be verified accordingly



Static Electrical Characteristics

Unless otherwise specified, these specifications apply for an operating junction temperature range of -40°C \leq Ta \leq 125°C and power supplies V_{BIAS} (i.e. V_{CC} & V_{BS}) = 15V. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM and are applicable to all logic input leads: HIN and LIN. The V_O and I_O parameters are referenced to GND and are applicable to the output leads: OUTA and OUTB.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions	
V _{IL}	Logic "0" input voltage			0.7		V00 40V 00V	
V _{IH}	Logic "1" input voltage	2.5				VCC=10V-20V	
V _{OL}	Low Level output voltage			0.1	→ ∨	lo=20mA	
V _{OH}	High Level output voltage, V _{BIAS} -Vo			2.45		lo=-20mA	
I _{IN+}	Logic "1" input bias current		40	60		VIN=3.3V	
I _{IN-}	Logic "0" input bias current			2	— μA -	VIN=0V	
C _{IN}	Equivalent input capacitance (†)		7		pF		
I _{QBS}	Quiescent VBS supply current		100	250		VIN=0V or 3.3V	
I _{QCC}	Quiescent VCC supply current		100	250	μΑ		
I _{LK}	Offset supply leakage current			20		VB=VS=200V	
V _{CCUVHYS}	Vcc supply undervoltage hysteresis		1				
V _{CCUV+}	Vcc supply undervoltage turn on threshold	6	7	8			
V _{CCUV} -	Vcc supply undervoltage turn off threshold	5	6	7	$\frac{1}{2}$		
$V_{BSUVHYS}$	Vcc supply undervoltage hysteresis		1		V		
V_{BSUV_+}	Vcc supply undervoltage turn on threshold	6	7	8			
V _{BSUV} -	Vcc supply undervoltage turn off threshold	5	6	7			
I _{O+}	Output high short circuit pulsed current ^(†)		2			VO=0V, PW=10us, Ta=25C	
I _{O-}	Output high short circuit pulsed current ^(†)		2		A	VO=15V, PW=10us, Ta=25C	

^(†) Guaranteed by design



Dynamic Electrical Characteristics

Unless otherwise specified, these specifications apply for an operating junction temperature range of -40°C \leq Ta \leq 125°C and power supplies V_{BIAS} (i.e. V_{CC} & V_{BS})= 15V, CL = 1000pF. Refer to Figure 1 for switching time definition.

Symbol	Definition		Тур	Max	Units	Test Conditions
Propagation delay characteristics						
t _{ON}	Turn-on propagation delay		60	120		VS=0V and 200V
t _{OFF}	Turn-off propagation delay		60	120		VS=0V and 200V
t _r	Turn-on rise time	_	22	46	no	
t _f	Turn-off fall time	_	15	35	ns	
DM1	Channel to channel turn on delay matching			20		
DM2	Channel to channel turn off delay matching			20		

Input/Output table

HIN	LIN	НО	LO
L	L	L	L
н	L	Н	L
L	Н	L	Н
н	Н	н	Н

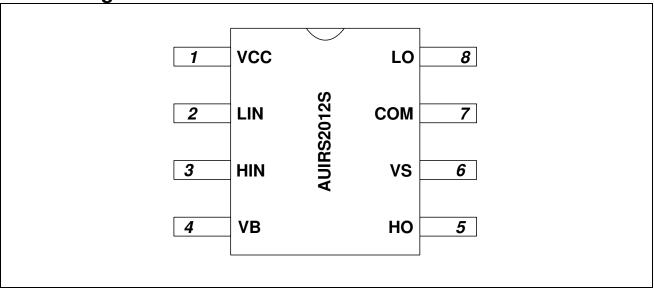
This table is held true in the voltages ranges defined in the recommended operating conditions section.



Lead Definitions

PIN	Symbol	Description		
1	VCC	Supply voltage		
2	LIN	Logic input for low side gate driver – in phase with LO		
3	HIN	Logic input for high side gate driver – in phase with HO		
4	VB	High side floating supply		
5	ОН	High side gate drive output		
6	VS	High side floating supply reference		
7	COM	Low side reference		
8	LO	Low side gate drive output		

Lead Assignment

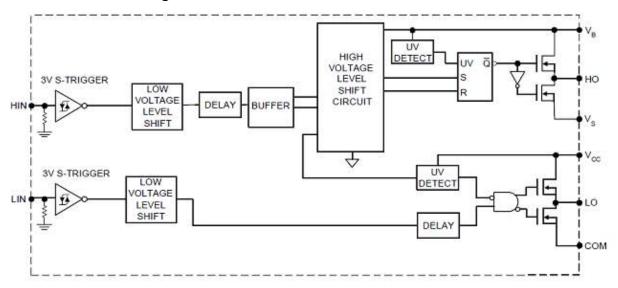


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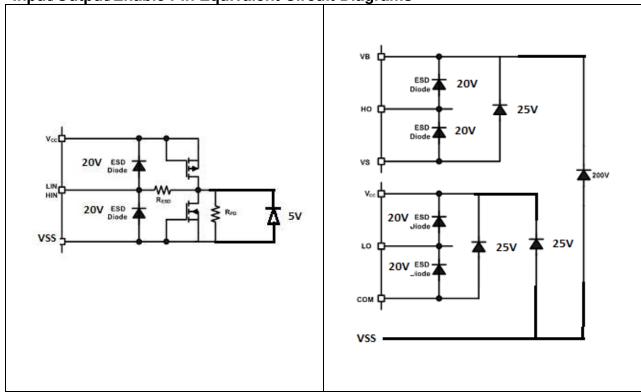
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Functional Block Diagram:

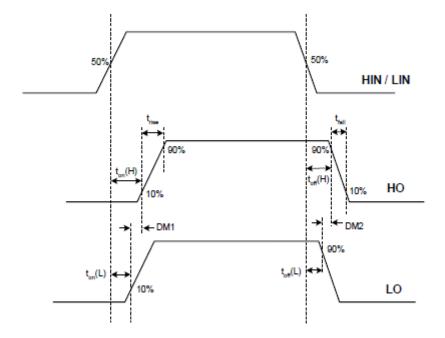






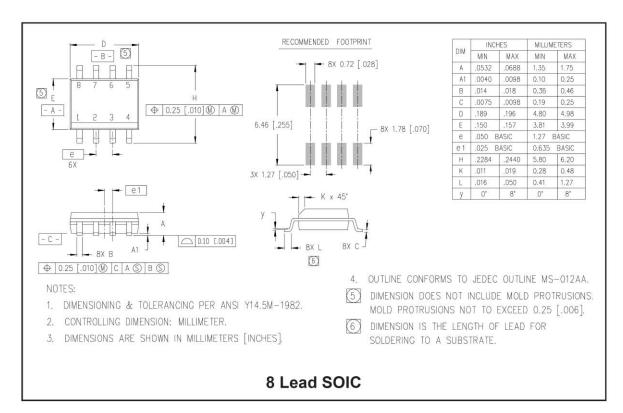


Timing waveforms





Package Information





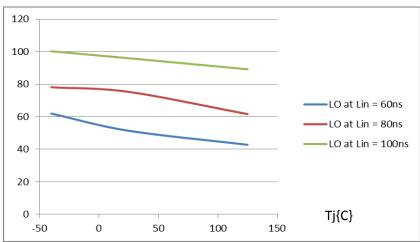
Application Information

When using the AUIRS2012S, some precautions have to be taken when very short Hin/Lin pulses are applied. In the following figures, the typical output pulse versus input pulse width distortion is shown, for both HO and LO and for three different input pulse widths.

As an example, applying a 60nsec Lin results in a 60nsec LO only at very low temperatures. At far as Tj increases LO width decreases to a bit more than 40nsec when Tj = Tjmax.

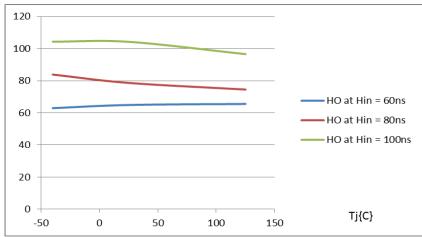
Different is the case when Hin short pulse is applied. Because of the effect of the internal level shifter, the HO pulse width is more stable with temperature.

Output pulse widht [ns]



LO Output pulse width vs Input pulse width and Ti

Output pulse widht [ns]



HO Output pulse width vs Input pulse width and Tj



Qualification Information

		Automotive (per AEC-Q100)		
Qualification Level		Comments: This part number passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.		
Moisture Sensitivity Level		SOIC8-N	MSL3,260C (per IPC/JEDEC J-STD-020)	
Machine Model		Class M2 (150V)		
		(per AEC-Q100-003)		
ESD	Human Body Model Class H2 (2500V) (AEC-Q100-002)		,	
	Charged Device Model		s C4 (875V) EC-Q100-011)	
		AEC-Q101-005		
IC Latch-UP Test		Class II, Level A (per AEC-Q100-004)		
RoHS Compliant	·	Yes		

[†] Qualification standards can be found at International Rectifier web site: http://www.irf.com



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